

961-E

Low-Solids No-Clean Liquid Flux

Product Description

Kester 961-E is a no-clean, non-conductive, non-corrosive, halogen and rosin-free liquid flux that is specifically designed for the wave soldering of conventional and surface mount circuit board assemblies. Essentially no residue remains after soldering. Boards are dry and cosmetically clean as they exit the wave solder machine, thus posing no interference with electrical testing. Kester 961-E has been developed for bare copper soldering applications. This comprehensive formulation possesses improved wetting characteristics, which continuing to exhibit superior corrosion inhibiting properties and providing a non-tacky residue that is considered non-corrosive and non-conductive by common industry specifications. This non-corrosive and non-conductive flux meets the strictest requirements of Bellcore TR-NWT-000078 and IPC-SF-818 specifications. A major advantage of this flux is the reduced odor associated with the soldering process.

Performance Characteristics:

- Halogen-free
- Improves soldering performance
- Reduced odor associated with soldering process
- Eliminates the need and expense of cleaning
- Non-corrosive tack-free residues
- No surface insulation degradation
- Compliant to IPC-SF-818
- Compliant to Bellcore TR-NWT-000078

Physical Properties

Specific Gravity: 0.801 ± 0.005

Anton Paar DMA 35 @ 25°C

Percent Solids (theoretical): 3.1

Acid Number (typical): 20.0 mg KOH/g of flux

Tested by potentiometric titration

Thinner: Kester 111-B

Reliability Properties

Copper Mirror Corrosion: Low

Tested to J-STD-004, IPC-TM-650, Method 2.3.32

Copper Corrosion: Low

Tested to J-STD-004, IPC-TM-650, Method 2.6.15

Spreading Test (typical): 84%

Tested to JIS-Z-3197

S.I.R., Bellcore (typical): Pass

Tested to Bellcore TR-NWT-000078

	Blank	961-E PD	961-E PU
Day 1(24h)	$1.6 \times 10^{12} \Omega$	$4.2 \times 10^{10} \Omega$	$2.1 \times 10^{10} \Omega$
Day 4(96h)	$2.9 \times 10^{12} \Omega$	$1.2 \times 10^{11} \Omega$	$3.5 \times 10^{10} \Omega$

Electromigration, Bellcore (typical): Pass

Tested to Bellcore TR-NWT-000078

Application Notes

Flux Application:

Kester 961-E can be applied to circuit board by spray or foam fluxing. To assure proper foaming action, filters and traps should be used on airlines to prevent dirt and excessive water from contaminating the flux. Flux deposition should be 120-240 μg of solids/ cm^2 (750-1500 μg of solids/ in^2). An air knife after the flux tank is recommended to remove excess flux from the circuit board and prevent dipping on the preheater surface.

Process Considerations:

The optimum preheat temperature for most circuit assemblies is 90-105°C (194-221°F), as measured on the top or component side of the assembly. The optimum preheat temperature for most circuit assemblies is 110-145°C (230-293°F), as measured at the bottom or component side of the assembly. It is still important to note that the optimum preheat temperature for a given assembly will depend on the circuit board design, board thickness, length of contact time with molten solder, solder wave shape, speed of solder flow and preheating time. Dwell time in the wave is typically 2-4 seconds. The wave soldering speed should be adjusted to accomplish proper preheating and evaporate excess solvent, which could cause spattering. For best results, speeds of 1.1-1.8 m/min (3½-6 ft/min) are used. The surface tension has been adjusted to help the flux form a thin film on the board surface allowing rapid solvent evaporation. The solderpot temperature is recommended to be 245-260°C (473-500°F) for Sn63Pb37 alloy. Above information is a guideline and it is advisable to note that the optimum settings for a given assembly may vary and this is dependent on the circuit board design, board thickness, components used and equipment used. A design of experiment is recommended to be done to optimize the soldering process.

Flux Control:

Control of the flux in the foam flux tank during use is necessary for assurance of consistent flux distribution on the circuit boards. The complex nature of the solvent system for the flux makes it imperative that Kester 111-B Thinner be used to replace evaporative losses. When excessive debris from circuit boards, such as board fibers and from the air line build up in the flux tank, these particulates will redeposit on the circuit boards which may create a build up of residues on probe test pins. It is, therefore, necessary to clean the tank and then replenish it with fresh flux when excessive debris accumulates in the flux tank. Incoming solderability inspection of circuit boards and components is advisable as a part of process control to maintain consistent soldering results.

Acid number is normally the most reliable method to control the flux concentration of low solids, no-clean fluxes. To check concentration, a simple acid-base titration should be used. Kester PS-20 test kit method gives a more accurate procedure than the use of auto-density controller in the determination of flux concentration. The test method is outlined as follows:

1. Dispense 5 ml of Kester PS-20 test kit solution into the test tube. The test tube has a 5 ml mark on it to facilitate this measurement. Add one drop of indicator, cap the test-tube and shake. The solution will change to a pink colour.
2. Using a dropper, a sample from the flux tank is then drawn and added to the test solution in the test tube, dropwise by counting exactly 17 drops. The dropper must be held in a *vertical* position.
3. Replace the stopper to the test tube and mix by shaking.
4. Observe the colour of the solution: some turbidity may be present, and this is acceptable. If the solution is pink, proceed to Step 5. If the solution is colourless (with or without turbidity), then proceed to Step 8.
5. Remove the stopper and add 1 more drop of flux using the same dropper.
6. Replace the stopper on the test tube and mix by shaking.
7. Observe the colour of the solution. If the solution is pink, return to Step 5. Repeat Step 5 and 6 until the solution turns clear. Refer to Table 1 for the proper value of thinner for the flux in use.

8. If the test solution is colourless (with or without turbidity) from Step 4, it is an indication that the flux concentration is too high. The approximate concentration and the corrective action needed can be determined as follows:
- Using a fresh test tube, fill with 5 ml of test solution. Add 1 drop of indicator solution. Cap the tube and shake.
 - Add 14 drops of flux with the dropper provided. Mix by shaking and observed the colour of the solution. If the solution is colourless, a supervisor should be contacted. This is an indication that the flux concentration has exceeded the recommended level. Corrective actions should be taken immediately to drain the flux and replenish it with fresh flux.
 - Continue adding flux, one drop at a time to the test solution, mixing between each additional drop. Keep count of the total number of drops needed to change the solution from pink to colourless. Using this count, refer to Table 1 for the correct amount of thinner to add to the flux tank.

Table 1: Flux tank adjustments using Kester PS-20 Test Kit	
Titer (Number of Drops)	Corrective Action
31	Attention should be given as to how well the flux is performing on the process line. The flux concentration is too low and may need to be adjusted to a higher concentration or entirely replaces with fresh flux.
30	Attention should be given as to how well the flux is performing on the process line. The flux concentration may be too low and may need to be adjusted with fresh flux.
24 - 28	No corrective action is needed.
23	No corrective action is needed or add 600 ml thinner per gallon (3.8L) of flux.
22	Add 800 ml thinner per gallon of flux.
21	Add 1000 ml thinner per gallon of flux.
20	Add 1250 ml thinner per gallon of flux.
19	Add 1400 ml thinner per gallon of flux.
18	Add 1650 ml thinner per gallon of flux.
17	Replace flux tank with fresh flux.

Cleaning:

Kester 961-E residues are non-conductive, non-corrosive and do not require removal in most applications. If residue removal is required, call Kester Technical Support.

Storage and Shelf Life:

Kester 961-E is flammable. Store away from sources of ignition. Shelf life is 1 year from date of manufacture when handled properly and held at 10-25°C (50-77°F).

Health & Safety:

This product, during handling or use, may be hazardous to health or the environment. Read the Material Safety Data Sheet and warning label before using this product.

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